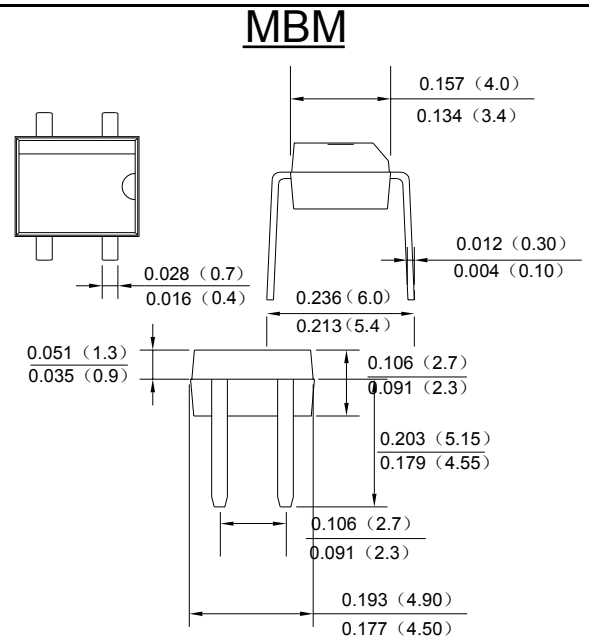


Features

- Glass Passivated Die Construction
- Low leakage
- Ideal for printed circuit board
- Surge overload rating-25A peak
- Designed for Surface Mount Application
- Plastic Material-UL Flammability 94V-0

Mechanical Data

- Case:Reliable low cost construction utilizing molded plastic technique
- Terminals:Plated Leads Solderable per MIL-STD-202,Method208
- Polarity:As Marked on Case
- Mounting Position:Any
- Marking:Type Number



Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.
 Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

TYPE NUMBER	SYMBOL	MB05MN	MB1MN	MB2MN	MB4MN	MB6MN	MB8MN	MB10MN	UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RWM}								
DC Blocking Voltage	V_{DC}								
RMS Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_A=40^\circ C$	I_o	0.5							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	25							A
Forward Voltage per element @ $I_F=0.5A$	V_{FM}	0.95							V
Peak Reverse Current @ $T_A=25^\circ C$ At Rated DC Blocking Voltage @ $T_A=125^\circ C$	I_R	5.0 500							μA
Typical Junction Capacitance per leg	C_J	13							pF
Typical Thermal Resistance per leg (Note 3)	$R_{\theta JA}$	70							$^\circ C/W$
	$R_{\theta JL}$	20							
Operating and Storage Temperature Range	T_J, T_{STG}	-55to+150							$^\circ C$

Note:1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

